



FMSW8032

Features

- · Single Pole Double Throw SMT Relay Switch
- DC to 18 GHz Frequency Range
- 2M Cycle Typical Operating Life
- 30W Average Power for Cold Switching @ 18 GHz
- · Hot Switching Capability
- -25°C to +70°C

Applications

- · High Performance Relay Switch
- · Military Communications

- Isolation 60 dB typ
- Insertion Loss 0.4 dB Typ
- VSWR 1.2:1 Typ
- +12Vdc @ 61 mA
- · EAR99 Export Compliance
- RoHS & Reach Compliant
- · Communications Systems
- · Test & Measurement

Description

The FMSW8032 is a single pole double throw electromechanical relay switch that operates from DC to 18 GHz. The design features a latching actuator with 2 coils and has a long and reliable lifespan up to 2M lifecycles typical (at low level) with excellent repeatability and thermal resistance. The innovative micro-mechanical design is in a miniature true surface mount package that's ideal for space limited applications. RF and command ports have gold plated access and the package can be mounted to a PWB using infrared reflow, forced air oven, or hand soldering processes. Impressive typical performance includes 0.4 dB insertion loss, 1.2:1 VSWR, and up to 60 dB isolation. Input power handling for hot switching is rated up to 40W, and operating voltage is +12 Vdc with 61 mA operating current. Performance is guaranteed over -25°C to +70°C and the switch assembly is RoHS and REACH compliant.

Electrical Specifications (TA = +25°C, DC Voltage = 12 Vdc)

Switch Type SPDT
Actuator Type Failsafe

Switching Sequence Break before Make Actuator Options Hot Switching

Description	Min	Тур	Max	Units
Frequency Range	DC		18	GHz
Impedance		50		
Operating Voltage	10.5	12	13	Volts
Actuating Current @ 12 Volts		61		mA
VSWR		1.2:1	1.7:1	
Insertion Loss		0.4	1	
Isolation	40	60		dB
Coil Resistance*		195		Ohms
Third Order Intermodulation**		-110		dBc
Input Power (CW)		60		Watts
(Average Power for Cold Switching (Reference				
RF Power Rating Table for Cold Switching))				





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Performance by Frequency

Description	F1	F2	F3	F4	F5	Units
Frequency Range	DC - 3	3 - 6	6 - 8	8 - 12.4	12.4 - 18	GHz
VSWR, Max	1.2:1	1.35:1	1.4:1	1.5:1	1.7:1	
Insertion Loss, Max	0.2	0.4	0.5	0.6	1	dB
Isolation, Min	50	40	40	40	40	dB
Input Power, Typ (Hot Switching)	40	25	5	3	1	Watts

Electrical Specification Notes:

Temperature: +23°C

CAUTION:At high frequency, manual soldering may generate spikes and RF characteristics degradation, due to air gaps between PC board and relay grounds

^{*}Coil Resistance: +/-10%

^{**}Third Order Intermodulation @ 1730 MHz (2 carries 20W)





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Operating mode Nominal operating voltage (Vdc) (across operating temperature range)		Failsafe			
		12 (10.5 to 1	3)		
Coil resistance (+/-10%) (Ohms)		195	10		
Operating current at 23°C (mA)		61			
RF and command ports		gold plated access, infrared reflow, forced air oven or hand soldering (Compatible with "lead free" soldering processes)			
Switching time	Making contacts	Max 5ms, including contact bounce time			
(Nominal voltage)	Breaking contacts	3ms 1 million cycles (2 million cycles typical at low leve			
Life	Cold switching (Max 120 cycles/min)				
Life	Hot switching (Max 20 cycles/min)	500.000 cycles (1W, impedance 50Ω , V.S.W.R. <1.25)			
Insulation		Dielectric test voltage	300Vms		
		Insulation resistance at 500Vdc	> 100MOhms		
Environme	ntal protection	RoHS compliant with the directive 2011/65 & its amendment 2015/863 Waterproofness according to IEC 60529 / IP64			
ı	Mass	7.5g max.			
	perature range (°C) nor condensation)	-25 to +70 (1)			
Storage temp	erature range (°C)	-55 to +85			
(According to MIL S	hocks STD 202, method 213B, and C)	100g / 6ms, ½ sine No chang	100g / 6ms, 1/2 sine No change of state		
	vibration 02, method 204)	Condition D : 10-2000Hz, 20g Operating Condition G : 10-2000Hz, 30g Non-operating			

If coil remains permanently supplied under -25°C, internal condensation may occur and generate contact failures. For such special applications from -25°C to -40°C, please contact us.

Mechanical Specifications

Size

 Length
 0.591 in [15.01 mm]

 Width/Diameter
 0.5 in [12.7 mm]

 Height
 0.472 in [11.99 mm]

 Weight
 0.017 lbs [7.71 g]

 Package Type
 Surface Mount

 Operating Life
 2,000,000 Cycles

Connectors

RF Connector Type SMT





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Environmental Specifications

Temperature
Operating Range
Storage Range
Construction
Shock

Sine Vibration

-25 to +70 deg C -55 to +85 deg C

Waterproof IAW IEC60529 / IP64

MIL STD 202, method 213B, Cond C, 100g / 6ms, $\frac{1}{2}$ sine No change

of state

 $Condition\ D: 10\text{-}2000Hz,\ 20g \quad Operating,\ Condition\ G: 10\text{-}2000Hz,$

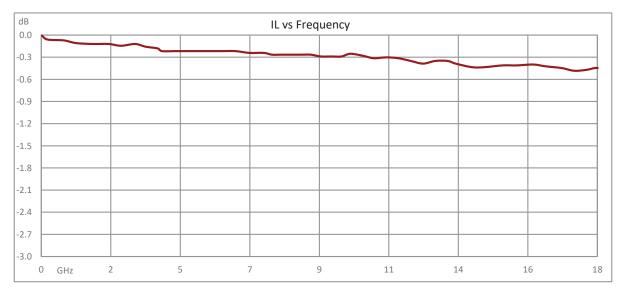
30g Non-operating

Compliance Certifications (see product page for current document)

Plotted and Other Data

Notes:

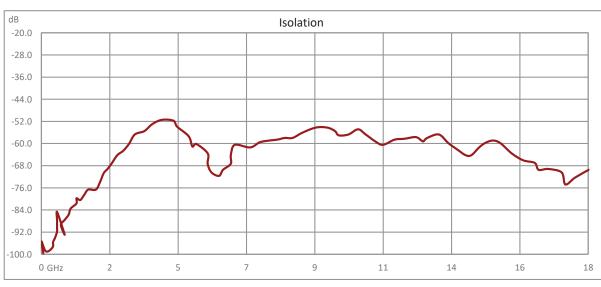
Typical Performance Data

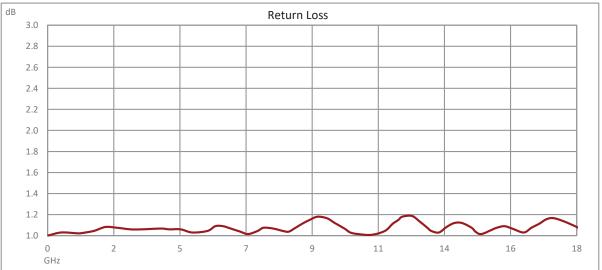






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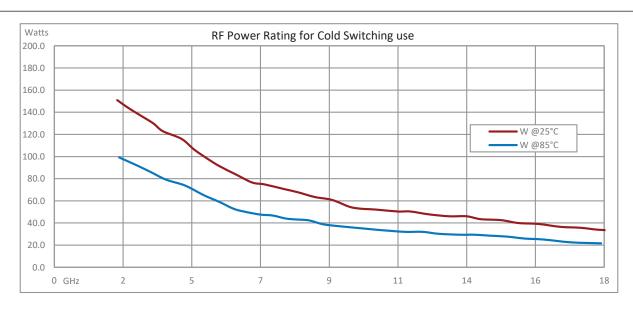








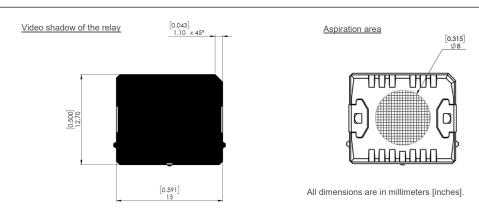
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PC BOARD MOUNTING

Substrate Types

Recommended substrates are ROGERS RO4003., Thickness 0.508 mm Cu double side 17.5µm. Recommended total thickness of RF tracks (copper over thickness + plating) : $40\mu m$.

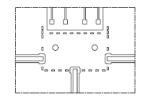
Other substrates may be used

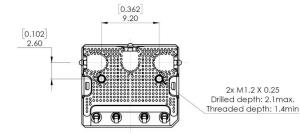
Board layout general outline

DXF or GERBER format file available upon request

Relay soldering

DXF format file available upon request





Optional fixing system: 2 screws M1.2





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RECOMMENDED SOLDERING PROCEDURE

- Soldering procedure using automatic pick and place

R516 series are « Lead Free », and Lead Free Sn-Ag3.5-Cu0.7 solder cream may be used as well as standard Sn63-Pb35-Ag2. RADIALL recommends using a « no clean - low residue » solder cream (5% solid residue of flux quantity) that will permit the elimination of the cleaning operation step after soldering. Note: Due to the gold plating of the switch PCB interface, it is important to use a paste made with silver. This will help in avoiding formation of intermetallics as part of the solder joint.

2-Solder paste deposition :

Solder cream may be applied on the board with screen printing or dispenser technologies. For either method, the solder paste must be coated to appropriate thickness and shapes to achieve good solder wetting. Please optically verify that the edges of the zone are clean and without contaminates, and that the PCB zoned areas have not oxydated. The design of the mounting pads and the stenciling area are available upon request, for a thickness of the silk-screen printing of 0.15 mm (0.006 ")

3-Placement of the component:

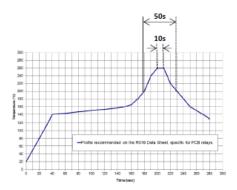
For small lightweight components such as chip components, a self-alignment effect can be expected if small placement errors exist. However, this effect is not as expected for relays components and they require a accurate positioning on their

soldering pads, typically +/- 0.1mm (+/-0.004").
Place the relay onto the PCB with automatic pick and place equipment. Various types of suction can be used.

RADIALL does not recommend using adhesive agents on the component or on the PCB.

4-Soldering: infra-red process

Please follow the RADIALL recommended max temperature profile for infra-red reflow or forced air convection :





Higher temperature (>260°C) and longer . duration process would damage ermanently the switches

5-Cleaning procedure:

On miniature relays, high frequency cleaning may cause the contacts to stick. If cleaning is needed, please avoid ultrasonic cleaning and use alcohol based cleaning solutions.



In-line cleaning process, spraying, immersion, especially under temperature, may cause a risk of degradation of internal contacts. For such cleaning process please contact us

6-Quality check

Verify by visual inspection that the component is centred on the mounting pads.

Solder joints : verify by visual inspection that the formation of meniscus on the pads are proper

B - Soldering procedure by manual operation



manual soldering is not recommended for high frequencies, as it generates resonand and lower RF characteristics due to gaps between PC board and relay grounds,

Refer to chapter A -

Deposit a thin layer of flux on solder paste area.

Allow the flux to evaporate a few seconds before applying the solder paste, this will prevent dilution of the paste.

2-Solder paste deposition :

RADIALL recommends depositing a small amount of solder paste on solder pad area by syringe, according to the nanual soldering pattern (available upon request).

Be careful, not to apply solder paste outside of the zone

3-Placement of the component:

During manipulation, avoid contaminating gold surfaces by contact with fingers.

Place the component on the mounting zone by pressing on the top of the relay lid

4-Hand soldering :

Iron wattage 30 to 60 W. To keep better RF characteristics, apply pressure on the relay lid during all the soldering stage, so as to reduce the air gap between the PC board and the relay.

If possible, fix the ground plane of the relay on the board with two M1.2 screws before the soldering stage. On each side of the central RF access, the RF body edge must be soldered to the ground of the PC board. To improve RF characteristics and avoid soldering the RF body on the ground, a conductive gasket may be used (please contact us for detailed application note).

5-Cleaning procedure :

Refer to chapter A - 5.

6-Quality check:

Verify by visual inspection that component is centred on the mounting pads.

Solder joints: verify by visual inspection that there is no solder excess on the RF pads.





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SPDT Electromechanical Relay Failsafe Switch, DC to 18 GHz, up to 30W, 12V, Hot Switching, SMT, 2M Lifecycles from Fairview Microwave is in-stock and available to ship same-day. All of our RF/microwave products are available off-the-shelf from our ISO 9001:2008 certified facilities in Lewisville, Texas. Fairview Microwave is RF on-demand.

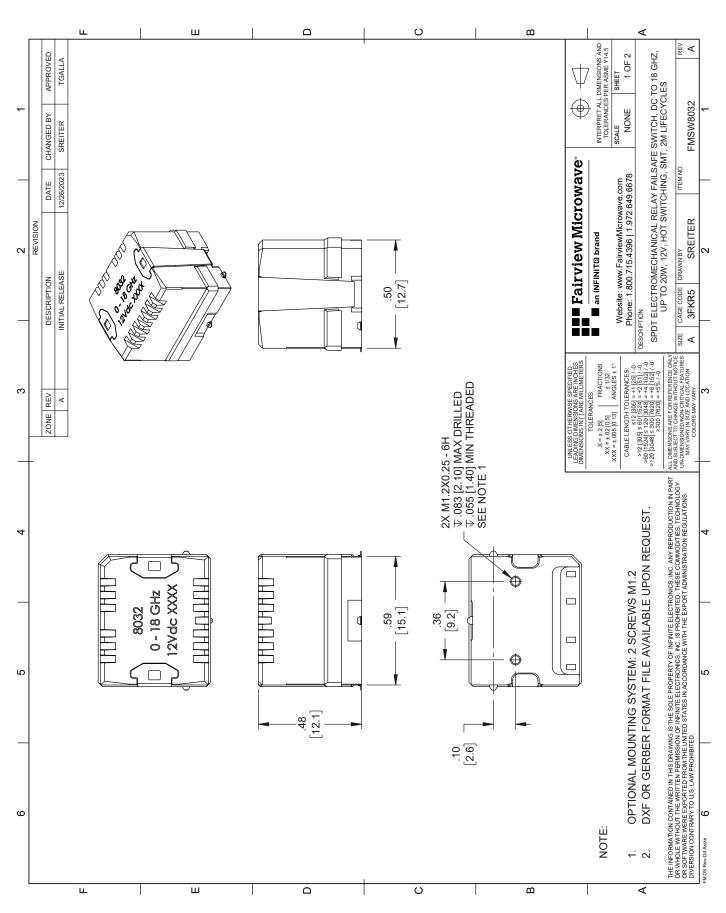
For additional information on this product, please click the following link: SPDT Electromechanical Relay Failsafe Switch, DC to 18 GHz, up to 30W, 12V, Hot Switching, SMT, 2M Lifecycles FMSW8032

URL: https://www.fairviewmicrowave.com/spdt-failsafe-18-ghz-electro-mechanical-relay-switch-30w-12v-hot-switching-smt-fmsw8032-p.aspx

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FMSW8032 CAD Drawing

SPDT Electromechanical Relay Failsafe Switch, DC to 18 GHz, up to 30W, 12V, Hot Switching, SMT, 2M Lifecycles



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